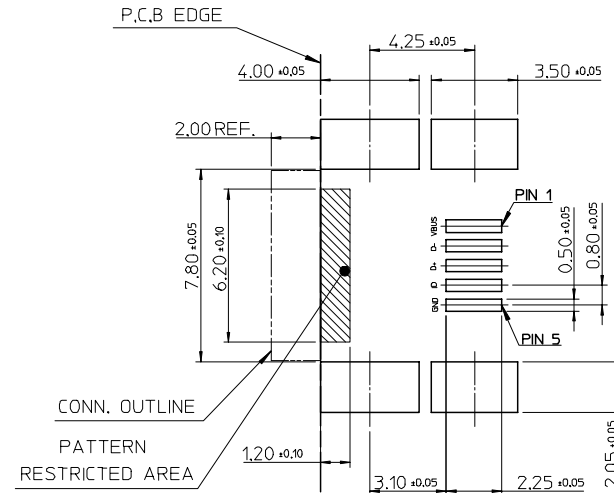


NOTE :

- MATERIAL :
HOUSING : NYLON GLASS FILLED , BLACK,UL94V-0
TERMINAL : COPPER ALLOY THICKNESS = 0.2 MM
SHIELD CASE : COPPER ALLOY THICKNESS = 0.4 MM
- PLATING :
TERMINAL:
CONTACT AREA : GOLD 0.75 MICROMETER MINIMUM.
SOLDER TAIL AREA : PURE TIN 3.8 MICROMETER MINIMUM.
UNDER PLATING : NICKEL 1.25 MICROMETER MINIMUM.
SHIELD CASE :
PURE TIN: 1-3 MICROMETER .
UNDER PLATING : NICKEL 1.0 MICROMETER MINIMUM.
- TAIL & NAIL COPLANARITY 0.1 mm MAXIMUM.
- PRODUCT SPECIFICATION REFER TO PS-67803-001.
- PACKAGING INFORMATION REFER TO PK-67503-001.



RECOMMENDED P.C.B. PATTERN LAYOUT

NEW RELEASE EC NO: SH2005-0155 DRAWN: XWANG 2005/01/04 CHKD: HARVEY 2005/01/05 APPR: YTYAP 2005/01/05	QUALITY SYMBOLS 	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
				MM ONLY	8:1	METRIC	
REV A	DESCRIPTION	4 PLACES	± ---	± ---	DRAWN BY	DATE	TITLE USB SERIES MINI-B REC. REC. ASS'Y FOR SMT W/O BACKOVER&PEG(LEAD-FREE) MOLEX INCORPORATED
		3 PLACES	± ---	± ---	LXWANG	2004/11/12	
		2 PLACES	± 0.25	± ---	CHECKED BY	DATE	
		1 PLACE	± 0.25	± ---	HARVEY	2004/11/12	
		ANGULAR ± 3 °		APPROVED BY	DATE	DOCUMENT NO. SD-67503-011	
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		YTYAP	2004/11/12		
				MATERIAL NO.	67503-1230		SHEET NO. 1 OF 1
SIZE A3 THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							